Si5448DU

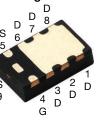
RoHS

FREE

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Vishay Siliconix





Top View

Bottom View

PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00775				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00947				
Q _g typ. (nC)	12.6				
I _D (A) ^{a, g}	25				
Configuration	Single				

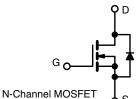
FEATURES

N-Channel 40 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- 100 % R_g and UIS tested
- COMPLIANT • Thermally enhanced PowerPAK ChipFET package HALOGEN -Compact footprint area - less than 6.09 mm² -Thin 0.8 mm profile
- 56 % lower R_{DS(ON)} than the prior generation
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC converters
- Motor drive control
- Synchronous rectification
- Battery management
- · Load switch



ORDERING INFORMATION	
Package	PowerPAK ChipFET
Lead (Pb)-free and halogen-free	Si5448DU-T1-GE3

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT	
		V _{DS}	40	V	
Gate-source voltage		V _{GS}	+20 / -16		
	T _C = 25 °C		25 ^a		
Continuous drain current (T _J = 150 °C)	T _C = 70 °C		25 ^a		
	T _A = 25 °C	I _D	15.9 ^{b, c}		
	T _A = 70 °C	1	12.7 ^{b, c}	A	
Pulsed drain current (t = 100 µs)		I _{DM}	100		
Cantinuaua aquiraa dirain diada aurrant	T _C = 25 °C		25 ^a		
Continuous source-drain diode current	T _A = 25 °C	I _S	2.6 ^{b, c}		
Single pulse avalanche current		I _{AS}	15		
Single pulse avalanche energy $L = 0.1 \text{ mH}$		E _{AS}	11.25	mJ	
	T _C = 25 °C		31		
Maximum power dissipation	T _C = 70 °C		20	w	
	T _A = 25 °C	PD	3.1 ^{b, c}		
	T _A = 70 °C	1	2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	<u></u>	
Soldering recommendations (peak tempera		260	-0		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	34	40	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	4	4	0/11		

Notes

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 90 °C/W.

g. $T_C = 25 \ ^{\circ}C.$

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Document Number: 76149

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ARAMETER SYMBOL TEST CONDITIONS		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	40	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050A	-	21.2	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.1	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	-	2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = +20 \text{ V} / -16 \text{ V}$	-	-	± 100	nA
7		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 10$ V, V_{GS} = 10 V	20	-	-	А
		V _{GS} = 10 V, I _D = 15 A	-	0.00646	0.00775	_
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A	-	0.00790	0.00947	Ω
Forward transconductance a	9 _{fs}	V _{DS} = 10 V, I _D = 15 A	-	80	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	1765	-	
Output capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	278	-	pF
Reverse transfer capacitance	C _{rss}		-	45	-	
Total gate charge	Qg	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	26.2	40	nC
			-	12.6	20	
Gate-source charge	Q _{gs}	V_{DS} = 20 V, V_{GS} = 4.5 V, I_{D} = 15 A	-	5.1	-	
Gate-drain charge	Q _{gd}		-	2.5	-	
Gate resistance	R _g	f = 1 MHz	0.3	1.5	3	Ω
Turn-on delay time	t _{d(on)}		-	10	20	
Rise time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{L}} = 1.7 \Omega, \text{ I}_{\text{D}} \cong 12 \text{ A},$	-	35	53	1
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R_g = 1 Ω	-	15	30	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	15	30	ns
Rise time	t _r	V_{DD} = 20 V, R_L = 1.7 Ω , $I_D \cong$ 12 A,	-	60	90	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	18	36	
Fall time	t _f		-	33	50	
Drain-Source Body Diode Characteristi	cs			•		
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	25	•
Pulse diode forward current	I _{SM}		-	-	100	A
Body diode voltage	V _{SD}	I _S = 13 A, V _{GS} = 0 V	-	0.8	1.2	V
Body diode reverse recovery time	t _{rr}		-	33	50	ns
Body diode reverse recovery charge	Q _{rr}		-	30	45	nC
Reverse recovery fall time	ta	I _F = 13 A, dl/dt = 100 A/μs, T _J = 25 °C	-	18	-	
Reverse recovery rise time	t _b		-	15	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

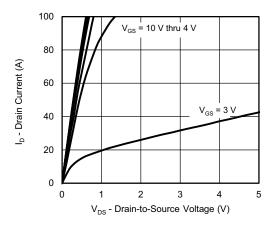
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

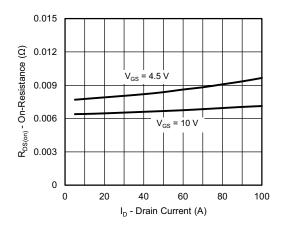


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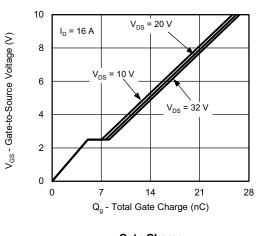
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



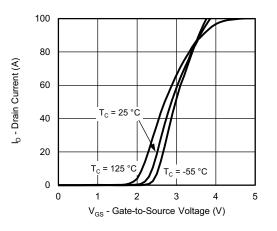
Output Characteristics



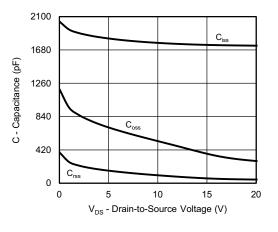
On-Resistance vs. Drain Current and Gate Voltage



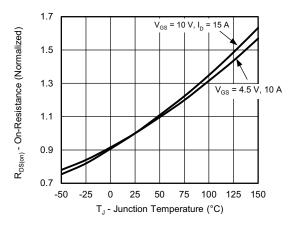
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

3

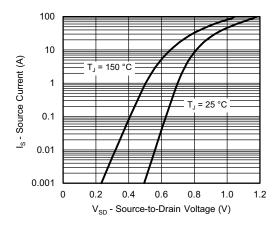
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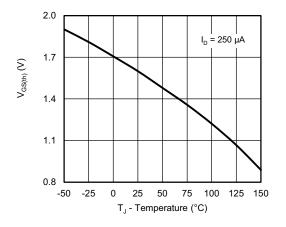


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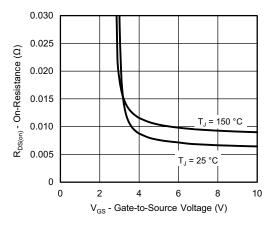
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



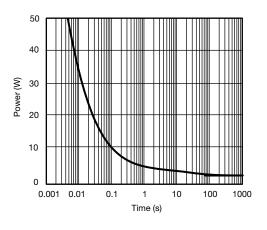
Source-Drain Diode Forward Voltage



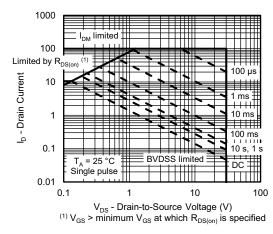
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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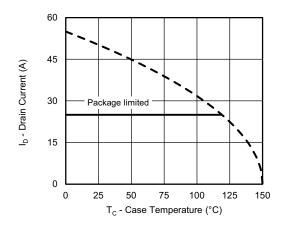
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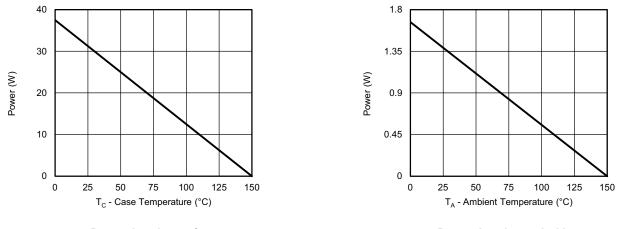
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case

Power, Junction-to-Ambient

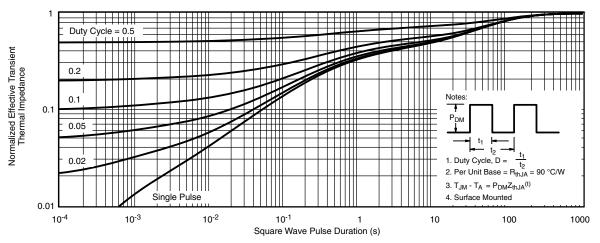
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

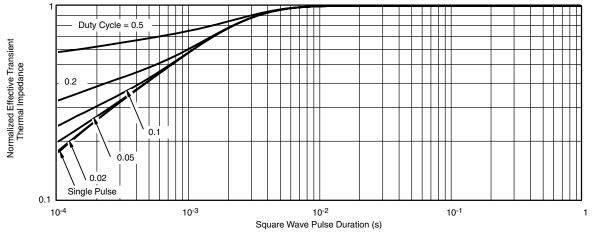


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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

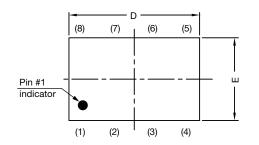
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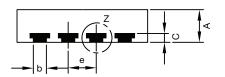
6

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PowerPAK[®] ChipFET[®] Case Outline

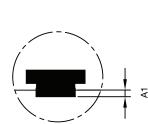




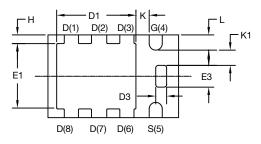


Side view of dual

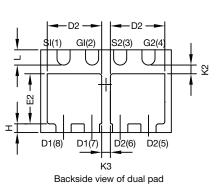
Side view of single



Detail Z



Backside view of single pad



DIM	DIM. MILLIMETERS						
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.85	0.028	0.030	0.033	
A1	0	-	0.05	0	-	0.002	
b	0.25	0.30	0.35	0.010	0.012	0.014	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.92	3.00	3.08	0.115	0.118	0.121	
D1	1.75	1.87	2.00	0.069	0.074	0.079	
D2	1.07	1.20	1.32	0.042	0.047	0.052	
D3	0.20	0.25	0.30	0.008	0.010	0.012	
E	1.82	1.90	1.98	0.072	0.075	0.078	
E1	1.38	1.50	1.63	0.054	0.059	0.064	
E2	0.92	1.05	1.17	0.036	0.041	0.046	
E3	0.45	0.50	0.55	0.018	0.020	0.022	
е	0.65 BSC			0.026 BSC			
Н	0.15	0.20	0.25	0.006	0.008	0.010	
К	0.25	-	-	0.010	-	-	
K1	0.30	-	-	0.012	-	-	
K2	0.20	-	-	0.008	-	-	
K3	0.20	-	-	0.008	-	-	
L	0.30	0.35	0.40	0.012	0.014	0.016	
C14-0630-Rev. E DWG: 5940	, 21-Jul-14						

Note

• Millimeters will govern

Revision: 21-Jul-14

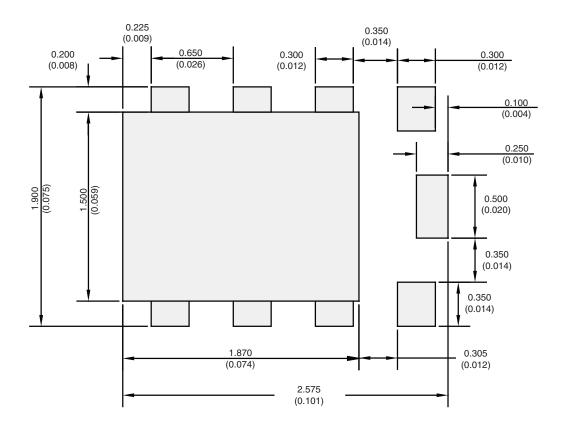
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Application Note 826 Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK[®] ChipFET[®] Single



Recommended Minimum Pads Dimensions in mm/(Inches)

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APPLICATION NOTE



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